PATENT ASSIGNMENT COVER SHEET

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Stylesheet Version v1.2

EPAS ID: PAT6784984

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
SHENG-YEN SHIH	06/23/2021
SHIH-HSIUNG HUANG	06/23/2021
YU-CHANG CHEN	06/23/2021

RECEIVING PARTY DATA

Name:	REALTEK SEMICONDUCTOR CORPORATION	
Street Address:	NO. 2, INNOVATION ROAD II, HSINCHU SCIENCE PARK	
City:	HSINCHU	
State/Country:	Taiwan ROC	
Postal Code:	300	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17360083

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	16313-382
NAME OF SUBMITTER:	JUSTIN KING
SIGNATURE:	/Justin King/
DATE SIGNED:	06/28/2021

Total Attachments: 2 source=a#page1.tif source=a#page2.tif

PATENT 506738168 REEL: 056686 FRAME: 0876

ASSIGNMENT

WHEREAS, I(we), SHENG-YEN SHIH, SHIH-HSIUNG HUANG and YU-CHANG CHEN whose post office address(es) appear(s) below, hereinafter referred to as ASSIGNOR, have invented certain new and useful invention entitled.

Control circuit for successive approximation register analog-to-digital converter

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(hereinafter referred to as the INVENTION) for which an a is executed on even date herewith unless at least one of to United States Design Patent was executed on: United States Design Patent was	tion No.:	necked: filed:	etters Patent /Utility Patent designating the
issued on as U.S. Patent N	o.:		
WHEREAS, REALTEK SEMICONDUCTOR CORP. Innovation Road II, Hsinchu Science Park, Hsinchu 3 is desirous of acquiring the entire right, title and interest possessions;	ORATION whos	e post office a	ter referred to as Accornic
NOW, THEREFORE, for good and valuable considerance ASSIGNOR, by these presents do sell, assign and transfer and to said INVENTION and application throughout the Patent granted on any division, continuation, continuation terms for which the same may be granted, including all p	r unto said ASSIG United States of n-in-part and reis	NEE, the entire America, in	re right, title, and interest in cluding any and all Letters plication for the full terms
ASSIGNOR further covenants that no assignments, sor entered into which would conflict with this Assignment	sale agreement o		
ALSO, ASSIGNOR hereby agrees to execute any docutiling, prosecution and maintenance of said application as aid Invention, including additional documents that missaid Invention, all without further consideration. As Assignee's expense, to identify and communicate to Assoncerning the Invention that are within Assignor's petestimony on behalf of Assignee that lawfully may be maintenance, litigation and defense of any patent appliantrument. Assignor's obligations under this instandministrators and other legal representatives.	or any other pate ay be required to SIGNOR also agree SIGNEE at ASSIGNOSSESSION or controlled to the patential of A dication or patential of A dication of	nt application affirm the rig ess, without f NEE's request rol, and to pro SSIGNOR in re-	n(s) in the United States for ghts of ASSIGNEE in and to further consideration and a documents and information ovide further assurances and respect of the prosecution
ALSO, ASSIGNOR hereby authorizes and requests the and all Letters Patent referred to above to ASSIGNEE, as the same, for ASSIGNEE's sole use and behoof, and for the successors, to the full end of the term for which such L same would have been held by ASSIGNOR had this assignment.	ne ASSIGNEE of the use and behoof efters Patent may	he entire right of ASSIGNEE the granted	t, title and interest in and to 'S legal representatives and as fully and entirely as the
ASSIGNOR NAME	Address		
SHENG-YEN SHIH	1	tion Road II, Taiwan (R.C	Hsinchu Science Park, D.C.)
Signature of Assignor Shen & Shill	Date of Signature	une 23, 202	1
Name of Witness (optional)	Name of Witness (c		
Signature of Witness (optional)	Signature of Witne	ss (Optional)	

PATENT REEL: 056686 FRAME: 0877

ASSIGNOR NAME SHIH-HSIUNG HUANG	Address No. 2, Innovation Road II, Hsinchu Science Park, Hsinchu 300, Taiwan (R.O.C.)
Signature of Assignor Shih-Heftung Huana	Date of Signature June 23, 2021
Name of Witness (optional)	Name of Witness (optional)
Signature of Witness (optional)	Signature of Witness (Optional)
ASSIGNOR NAME	Address

ASSIGNOR NAME YU-CHANG CHEN	Address No. 2, Innovation Road II, Hsinchu Science Park, Hsinchu 300, Taiwan (R.O.C.)
Signature of Assignor Yu-Chan Chan	Date of Signature June 23, 2021
Name of Witness (optional)	Name of Witness (optional)
Signature of Witness (optional)	Signature of Witness (Optional)

PATENT REEL: 056686 FRAME: 0878

RECORDED: 06/28/2021